Electronic Supplementary Information (ESI)

Phase diagram and structural evolution of tin/indium (Sn/In) nanosolder particles: from a non-equilibrium state to an equilibrium state

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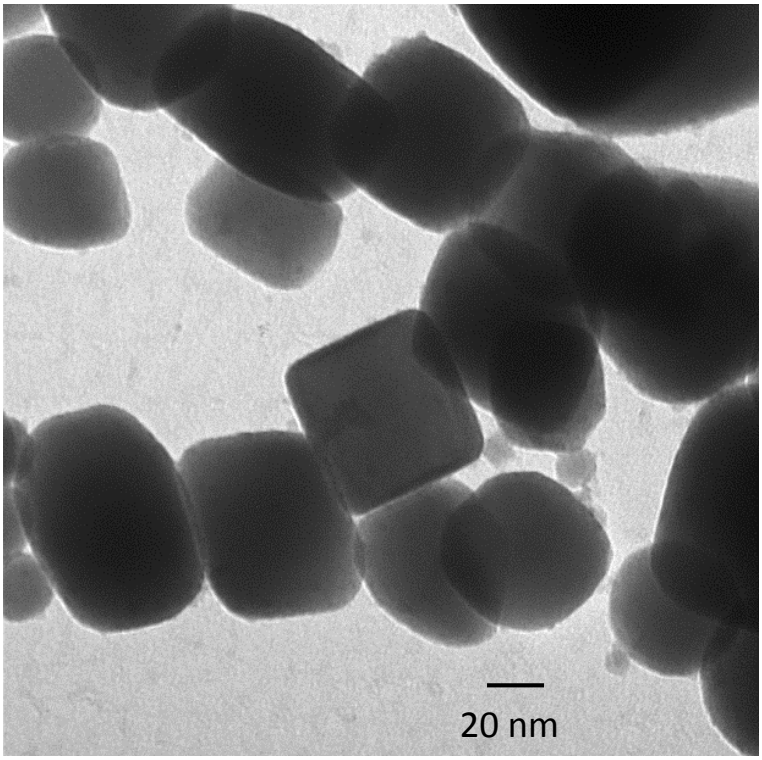

Fig. S-1: TEM image of Sn/In 50/50 nanosolder particles; the size range of the nanoparticles is from 38 nm to 60 nm.

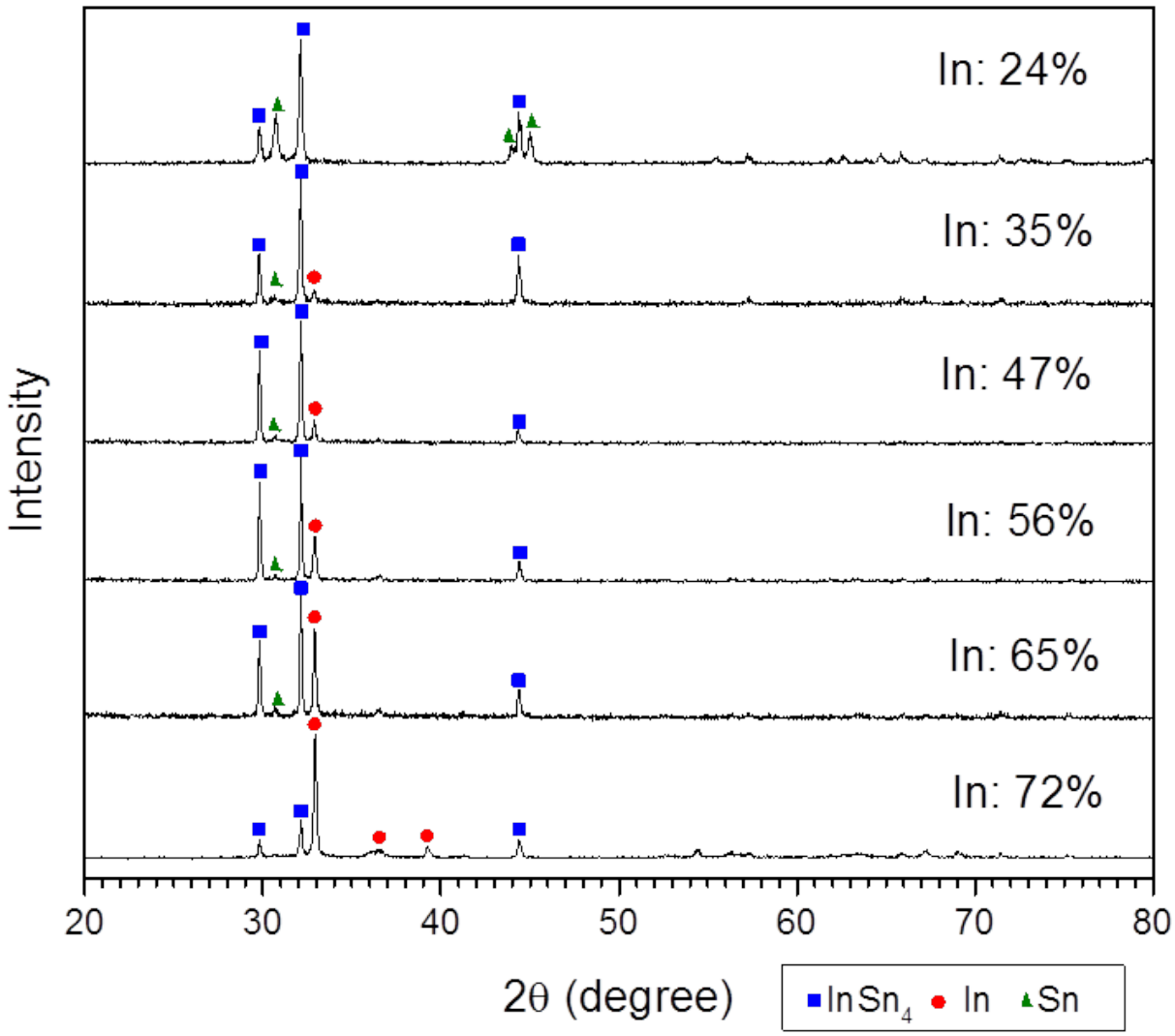

Fig. S-2: XRD spectra of the as-synthesized Sn/In nanosolder particles at different indium compositions.[1]

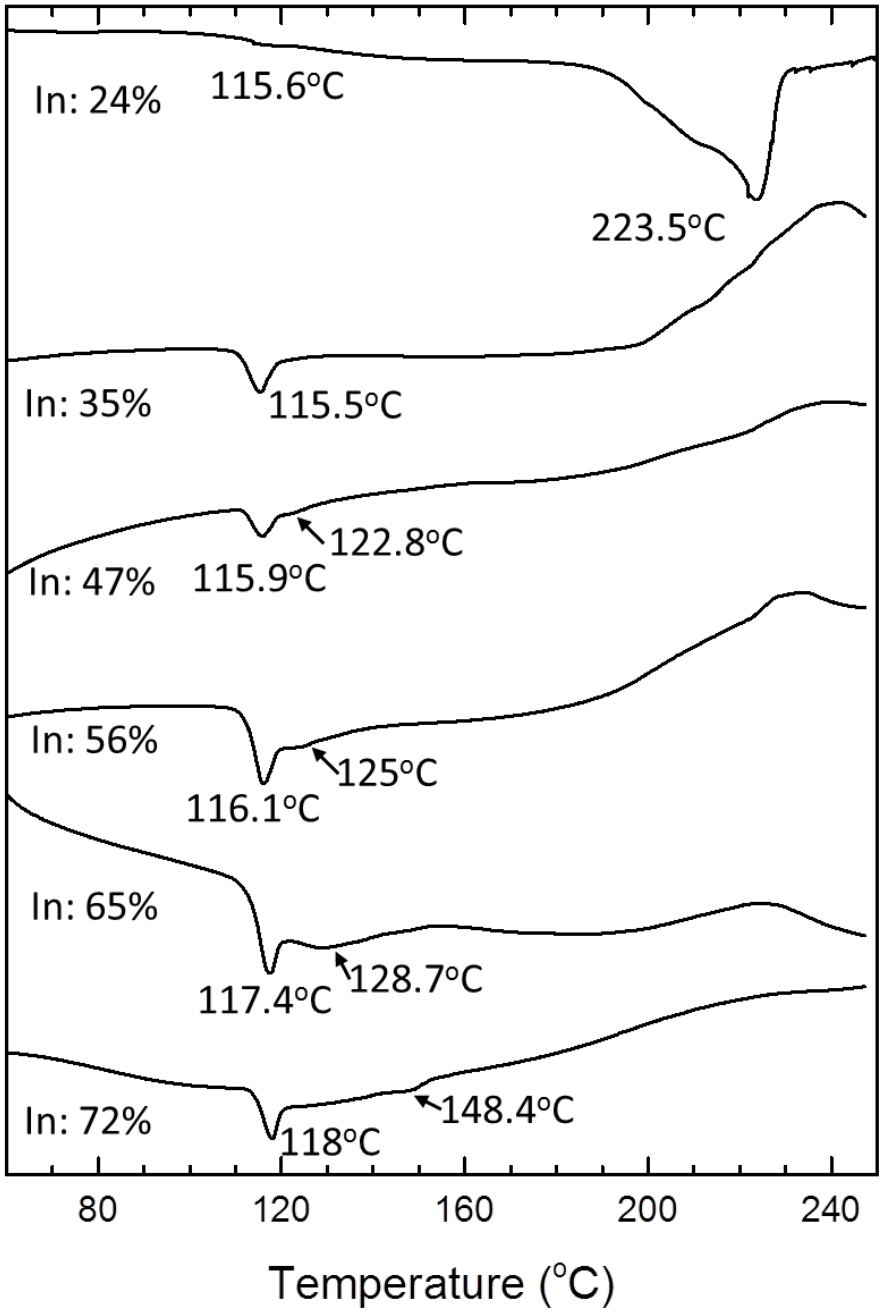

Fig. S-3: DSC curves of the as-synthesized Sn/In nanosolder particles at different indium compositions. [1]

Reference:

1. Y. Shu, K. Rajathurai, F. Gao, Q. Cui, Z. Gu. "Synthesis and Thermal Properties of Low Melting Temperature Tin/Indium (Sn/In) Lead-free Nanosolders and Their Melting Behavior in a Vapor Flux", *Journal of Alloys and Compounds* 2015, *626*, 391-400.